

# Youngdo Kim

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## RESEARCH INTERESTS

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- Biophotonics
- Digital holographic microscopy
- Deep learning
- Fluid mechanics
- Particle tracking velocimetry

## DEGREE & EDUCATION

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### B.S. IN MECHANICAL ENGINEERING

Feb 2019 - Present

Pohang University of Science and Technology (POSTECH), Pohang, Republic of Korea  
Current GPA : 3.90 / 4.3 , Major GPA : 4.05 / 4.3

### HIGH SCHOOL DIPLOMA

Mar 2016 - Feb 2019

Daegu Science High School (DSHS), Daegu, Republic of Korea

## RESEARCH EXPERIENCE

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### UNDERGRADUATE RESEARCHER

Jul 2024 – Present

Future Fluid and Biomimetics Laboratory (PI: Prof. Sang Joon Lee), POSTECH, Pohang, Republic of Korea

- Physics driven and coordinate-based 3D morphology recovery of microparticles from a single shot digital holographic microscopy

### UNDERGRADUATE RESEARCHER

Jul 2020 – Dec 2022

Future Fluid and Biomimetics Laboratory (PI: Prof. Sang Joon Lee), POSTECH, Pohang, Republic of Korea

- Supervised learning-based analysis of 3D translational and rotational dynamics on red blood cells using a digital in-line holographic microscopy
- Supervised learning-based orientation analysis of red blood cells using digital holographic microscopy
- Smartphone-based holographic monitoring of polydisperse suspended particulate matter concentrations
- Acceleration in the settling velocity of airborne particulate matter on hairy plant leaves
- Development of an efficient condensation surface using liquid-infused surface(LIS) in a solar desalination system

**RESEARCH INTERN****Mar 2017 - Feb 2018**

Fluid and Interface Laboratory (PI: Prof. Hyungsoo Kim), KAIST, Daejeon, Republic of Korea

- Conceptualization and analysis of Worthington jet dynamics in oblique bath

**PUBLICATIONS**

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**JOURNAL PUBLICATIONS**

Notes: # indicates equally contributing first authors. \* indicates the corresponding author(s).

1. **Y. Kim**#, J. Kim#, E. Seo, S. Lee\*, AI-based analysis of 3D position and orientation of red blood cells using digital in-line holographic microscopy, *Biosensors and Bioelectronics* **223**, 115232 (2023)
2. J. Kim, J. Kim, **Y. Kim**, T. Go, S. Lee\*, Acceleration in the settling velocity of airborne particulate matter on hairy plant leaves, *Journal of Environmental Management* **332**, 117313 (2023)
3. J. Kim, **Y. Kim**, K. Howard, S. Lee\*, Smartphone-based holographic monitoring of polydisperse suspended particulate matter concentrations, *Scientific Reports* **12**, 22609 (2022)
4. Y. Lee#, S. Shin#, G. Choi, H. Jeon, **Y. Kim**, H. Kim\*, Symmetry breaking of Worthington jets by gradients in liquid pool depth, *Physics of Fluids* **32**, 112104 (2020)
5. J. Kim, **Y. Kim**, K. Howard, S. Lee\*, Spatiotemporal tracking of rotational dynamics of erythrocytes using AI-assisted digital in-line holographic microscopy, under review (2024)

**CONFERENCE PROCEEDINGS & PRESENTATIONS**

**Y. Kim**, S. Jee, Analysis of 3D orientation of red blood cells using digital in-line holographic microscopy, The 12th National Congress of Fluids Engineering (NCFE), Changwon, South Korea, (2022) -poster

**AWARDS & HONORS**

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- Mechanical Engineering Student Award, POSTECH, 2022
- Outstanding Capstone Design Award, POSTECH, 2022
- Excellence Paper Award, The 12th National Congress of Fluids Engineering, 2022
- The National Scholarship for Science and Engineering, Fall 2021 – Present
- Jigok Scholarship, POSTECH, 2019-2021

**OTHER EXPERIENCE**

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**STUDENT MENTOR PROGRAM****Feb 2020 - Jun 2020**

POSTECH Mechanical Engineering Mentor &amp; Mentee Program

- Teaching undergraduate mentees solid mechanics

**STUDENT MENTOR PROGRAM****Feb 2022 - Jun 2022**

POSTECH Mechanical Engineering Mentor &amp; Mentee Program

- Teaching undergraduate mentees solid mechanics

**MILITARY SERVICE****Dec 2022 – Jun 2024**

Korea Army, Republic of Korea

- Landmine removal operations and explosive handling
- Attending military AI competition 2023, Ministry of National Defense